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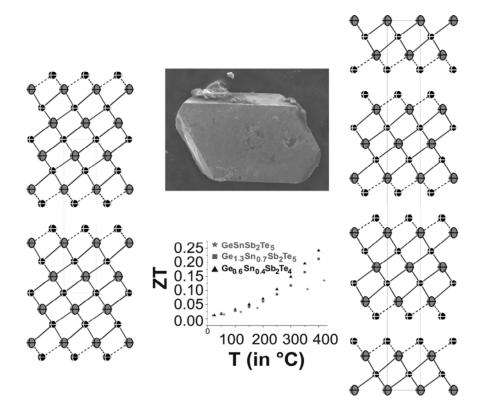
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Layered germanium tin antimony tellurides: element distribution, nanostructures and thermoelectric properties

Simon Welzmiller, Tobias Rosenthal, Pirmin Ganter, Lukas Neudert, Felix Fahrnbauer, Philipp Urban, Christian Stiewe, Johannes de Boor and Oliver Oeckler*



Layered compounds in the system Ge/Sb/Te show improved thermoelectric properties upon doping with Sn due to a reduced thermal conductivity κ . The element distribution in mixed crystals was re-fined using resonant synchrotron single-crystal diffraction data and the structure models were confirmed by comparing electron microscopy (HRTEM) and diffraction (SAED) with simulations.

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Layered germanium tin antimony tellurides: element distribution, nanostructures and thermoelectric properties

Simon Welzmiller, ^a Tobias Rosenthal, ^b Pirmin Ganter, ^b Lukas Neudert, ^b Felix Fahrnbauer, ^a Philipp Urban, ^a Christian Stiewe, ^c Johannes de Boor ^c and Oliver Oeckler* ^a

In the system Ge/Sn/Sb/Te, there is a complete solid solution series between GeSb₂Te₄ and SnSb₂Te₄. As Sn₂Sb₂Te₅ does not exist, Sn can only partially replace Ge in Ge₂Sb₂Te₅; samples with 75% or more Sn are not homogeneous. The joint refinement of high-resolution synchrotron data measured at the K-absorption edges of Sn, Sb and Te combined with data measured at offedge wavelengths unambiguously yields the element distribution in 21R-Ge_{0.6}Sn_{0.4}Sb₂Te₄ and 9P-Ge_{1.3}Sn_{0.7}Sb₂Te₅. In both cases, Sb predominantly concentrates on the position near the van der Waals gaps between distorted rocksalt-type slabs whereas Ge prefers the position in the middle of the slabs. No significant antisite disorder is present. Comparable trends can be found in related compounds; they are due to the single-side coordination of the Te atoms at the van der Waals gap, which can be compensated more effectively by Sb3+ due to its higher charge in comparison to Ge2+. The structure model of 21R-Ge0.6Sn0.4Sb2Te4 was confirmed by highresolution electron microscopy and electron diffraction. In contrast, electron diffraction patterns of 9P-Ge_{1.3}Sn_{0.7}Sb₂Te₅ reveal a significant extent of stacking disorder as evidenced by diffuse streaks along the stacking direction. The Seebeck coefficient is unaffected by the Sn substitution but the thermal conductivity drops by a factor of 2 which results in a thermoelectric figure of merit ZT = \sim 0.25 at 450 °C for both Ge_{0.6}Sn_{0.4}Sb₂Te₄ and Ge_{1.3}Sn_{0.7}Sb₂Te₅, which is higher than \sim 0.20 for unsubstituted stable layered Ge/Sb/Te compounds.

Introduction

Compounds in the system Ge-Sb-Te (so-called GST materials) with the general formula (GeTe)_nSb₂Te₃ are widely used as phase-change materials (PCM) on rewritable optical data storage media and in non-volatile PCRAM devices. [1-4] Data is stored by means of a reversible phase transition from a metastable crystalline to an amorphous phase of PCMs, which involves significant changes of the optical and electrical properties. Consequently, erasing corresponds recrystallization. The performance mainly depends on kinetic effects as a fast transition between the amorphous and crystalline phases is crucial for efficient write-erase cycles. The substitution of thin-film GST materials with Sn [5-10] increases the crystallization speed which enables fast erasing. It additionally decreases the melting point, which is favourable since it means that less energy is required for the

amorphization. Both effects are due to the lower average bond dissociation energy of Sn-Te compared to Ge-Te.[11] As the materials properties required for PCMs are, at least in part, similar to those of good thermoelectrics, [12] metastable GST materials turned out to exhibit thermoelectric figures of merit ZT up to 1.3. [13] ZT depends on the Seebeck coefficient S, the electrical σ and the thermal conductivity κ : $ZT = S^2 \sigma T \kappa^{-1}$. Approaches to improving the ZT values focus on either influencing κ or the power factor $S^2\sigma$. However, both are interdependent according to the Wiedemann-Franz law $(\lambda/\sigma = LT)$; with Lorenz number L). Sn doping should influence the thermoelectric properties as phonon scattering is enhanced when an element with a different atomic number is included on the same Wyckoff position. $^{[14]}$ In $(GeTe)_nSb_2Te_3$ phases with $n \ge 3$, quenching the disordered rocksalt-type high-temperature phase (stable above ~500 °C), which corresponds to the metastable crystalline phase of PCMs, yields metastable

pseudo-cubic materials with pronounced nanostructures. They are often characterized by irregularly spaced and often intersecting defect layers $^{[13-16]}$ with limited lateral extension whose concentration depends on the GeTe content n. The highest *ZT* values (1.3 at ~450 °C) were observed for quenched phases with n = 12 or 19. $^{[13]}$

At temperatures below ~500 °C – the exact temperature mainly depending on n –, layered trigonal phases $(Ge_{1-x}Sn_xTe)_nSb_2Te_3$ with less favorable thermoelectric properties are thermodynamically stable. They are formed by long-term annealing at temperatures below the existence range of the cubic high-temperature phase or during very slow cooling. These phases contain distorted rocksalt-type slabs with alternating anion (Te) and cation layers (Ge/Sb) which are separated by van der Waals gaps. In the case of 9P-Ge₂Sb₂Te₅ or 21R-GeSb₂Te₄, these slabs consist of 9 or 7 alternating anion and cation layers, respectively (compare Figures 3 and 7). [17,18] Sn-doped GST materials are a challenge for crystal structure determination as elements with similar electron counts (Sb, Sn, Te) are often disordered in comparable systems. The almost non-existing scattering contrast requires resonant X-ray diffraction to determine the element distribution over the Wyckoff sites present.[19-21] In diffraction experiments with wavelengths near the absorption edges, anomalous dispersion significantly changes the atom form factors of the respective elements and thus enhances the scattering contrast. The element distribution in single crystals of multinary tellurides has been unambiguously investigated by means of resonant X-ray diffraction, e. g. for $39R-M_{0.067}Sb_{0.667}Te_{0.266}$ (M=Ge, Sn), [22] 21R-SnSb₂Te₄^[23] and 9P-Ge₂Sb₂Te₅^[24]Therefore, it is a promising method to get a deeper insight in the structure-properties relationship of thermoelectric Sn-doped GST materials.

Results and Discussion

The solid solution series $(Ge_{1-x}Sn_x)Sb_2Te_4$ (x = 0-1)

Samples with the compositions $(Ge_{1-x}Sn_x)Sb_2Te_4$ (x = 0.25, 0.40, 0.50, 0.75) were obtained from stoichiometric melts of the elements. Rietveld refinements prove that they are single-phase and that all members of the solid solution series exhibit a 21R-type structure (space group $R\overline{3}m$), they are isostructural to the end members GeSb₂Te₄ [25] and SnSb₂Te₄. [23] The trend of the lattice parameters is linear according to Vegard's law over the whole region of the solid solution (Figure 1). The occupancy factors were chosen according to the results of the single-crystal structure analysis based on resonant scattering data (see below). The occupancy of Sb on each cation's Wyckoff position was fixed to the value of Ge_{0.6}Sn_{0.4}Sb₂Te₄ and the difference to full occupancy was filled with Ge and Sn according to their site preference ratio from the resonant single crystal refinement. With increasing Sn content, the bond lengths between cation and anion positions slightly increase according to the Rietveld refinement results; however, the standard deviations are rather large (cf. Figure S1 in the Supplementary Information). Yet, this reflects the larger ionic radius of Sn in comparison to Ge. Figure 2 shows the result of the Rietveld refinement for $Ge_{0.5}Sn_{0.5}Sb_2Te_4$, the other plots are given in the Supplementary Information (Figures S2 - S4). Crystallographic data are summarized in Table 1, the refined parameters are given in Table 2.

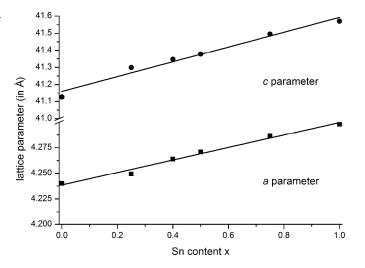


Figure 1: Vegard's plot of compounds in the series ($Ge_{1-x}Sn_x$) Sb_2Te_4 (x = 0 - 1); c parameter (top) and a parameter (bottom); values for $GeSb_2Te_4$ [25] and $SnSb_2Te_4$ [23] taken from literature.

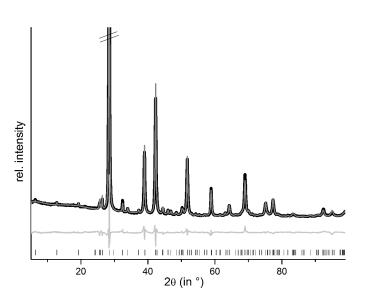


Figure 2: Rietveld refinement of 21R-Ge_{0.5}Sh₂Te₄ (the strongest reflection is cut off); vertical lines indicate calculated reflection positions, experimental (black) and calculated pattern (gray) and difference plot (below) are shown.

In order to precisely determine the element distribution, a single crystal for resonant diffraction experiments was grown by chemical transport (cf. Experimental Section). Energy-dispersive X-ray spectroscopy (EDX) yields a composition of $Ge_{9.5(5)}Sn_{6.0(5)}Sb_{28.7(3)}Te_{55.8(4)}$ (averaged from 3 point analyses). Taking into account normal valence states, this corresponds to the formula $Ge_{0.6}Sn_{0.4}Sb_2Te_4$ (calculated atom-%:

Ge_{8.6}Sn_{5.7}Sb_{28.6}Te_{57.1}). This compound forms a 21R In₃Te₄-type structure with distorted rocksalt-type slabs as described above, which is depicted in Figure 3. [25-29] The three slabs per unit cell are separated by van der Waals gaps with Te-Te distances (between the atoms A2, cf. Table 4 and Figure 3) of 3.720 Å which indicate a partially covalent interaction (sum of van der Waals radii: 4.42 Å).[³⁰] This is comparable to the corresponding Te-Te distances in 21R-type phases like GeSb₂Te₄^[25], SnSb₂Te₄^[23] or PbSb₂Te₄.[³¹], Among all these phases, these distances do not differ more than about 2%. The bond lengths in the distorted 3 + 3 coordination of the cations (C2) next to the van der Waals gap are 2.959 Å towards the gap (C2-A2) and 3.2117 Å towards the center of the slabs (C2-A1), respectively (cf. Figure 3); the bond angles are A2-C2-A2: 92.19°; A1-C2-A1: 83.18 and A1-C2-A2: 92.15°. The cationcentered octahedra in the middle of the slabs are almost regular with bond lengths of 3.045 Å and angles of 88.88° and 91.12° respectively (A1-C1-A1). While Sn is almost uniformly distributed over both cation positions (occupancy factors 11.8% on position C2 and 16.3% on C1, respectively, cf. Figure 3), Sb clearly prefers the position near the van der Waals gap (77.1% on position C2). In contrast, the position in the centre of the rocksalt-type slab (C1) shows almost equal amounts of Ge (37.8%) and Sb (45.8%). The same trend can be found in comparable compounds like GeSb₂Te₄, SnSb₂Te₄, SnSb₂Te₄, PbSb₂Te₄ and GeBi₂Te₄. Tables 3 and 4 summarize the crystal data and give parameters of the refinement. The atomic coordinates obtained from the single-crystal data and from the corresponding Rietveld refinement are very similar, taking into account their standard deviation, the single-crystal values are of course more precise.

Table 1: Results from the Rietveld refinements for $(Ge_{1-x}Sn_x)Sb_2Te_4$ compounds with $x=0.25,\,0.4,\,0.5,\,0.75$

Compound	$Ge_{0.75}Sn_{0.25}Sb_2Te_4$	$Ge_{0.6}Sn_{0.4}Sb_2Te_4$	$Ge_{0.5}Sn_{0.5}Sb_2Te_4$	$Ge_{0.25}Sn_{0.75}Sb_2Te_2$
Formula mass (in g mol ⁻¹)	838.06	844.97	849.58	861.11
F(000)	1039.5	1048	1053	1066.5
Crystal system / space group		trigonal / R	<i>Bm</i> (no. 166)	
Z		3		
Cell parameters (in Å) Cell volume (in Å ³)	a = 4.24950(12) c = 41.299(3) 645.87(6)	a = 4.26384(14) c = 41.346(3) 650.973(7)	a = 4.27072(13) c = 41.376(3) 653.66(6)	a = 4.28656(14) c = 41.495(4) 660.30(7)
X-ray density (in g·cm ⁻³)	6.46	6.47	6.48	6.50
Absorption coefficient (in mm ⁻¹)	162.24	163.77	164.97	167.88
Wavelength (in Å) 2θ range (in °)		Cu- $K_{\alpha 1}$ ($\lambda = 1$) $5 \le 20$	· · · · · · · · · · · · · · · · · · ·	
Profile function	fun	ndamental parameters (di	rect convolution approac	eh)
Restraints		6		
Reflections	115	117	117	119
Parameters / thereof background	37 / 18	37 / 18	37 / 18	37 / 18
R_p / R_{wp}	0.0235 / 0.0349	0.0234 / 0.0340	0.0238 / 0.0342	0.0246 / 0.0369
R_{Bragg}	0.0350	0.0331	0.0333	0.0332
Goof	1.326	1.436	1.451	1.567

Table 2: Wyckoff positions, atom coordinates, occupancy factors (cf. text: according to nominal composition, not refined) and isotropic displacement parameters B_{iso} (in \mathring{A}^3) for $(Ge_{1:x}Sn_x)Sb_2Te_4$ compounds with x=0.25, 0.4, 0.5, 0.75.

Atom	atom Formula		Wyckoff position	хух	Occupancy	$\mathrm{B}_{\mathrm{iso}}$
Ge/Sn/Sb	Ge _{0.75} Sn _{0.25} Sb ₂ Te ₄	C1	3 <i>a</i>	0 0 0	0.4065 / 0.1355/ 0.458	1.56(13)
	$Ge_{0.6}Sn_{0.4}Sb_2Te_4$			0 0 0	0.378 / 0.1634 / 0.458	1.33(13)
	$Ge_{0.5}Sn_{0.5}Sb_2Te_4$			0 0 0	0.271 / 0.271 / 0.458	1.10(9)
	$Ge_{0.25}Sn_{0.75}Sb_{2}Te_{4} \\$			0 0 0	0.1355 / 0.4065 / 0.458	1.90(14)
Ge/Sn/Sb	$Ge_{0.75}Sn_{0.25}Sb_2Te_4$	C2	6 <i>c</i>	0 0 0.42746(16)	0.1718 / 0.0572 / 0.771	1.56(13)
	$Ge_06Sn_04Sb_2Te_4$			0 0 0.42740(16)	0.1107 / 0.1183 / 0.771	1.34(13)
	$Ge_{0.5}Sn_{0.5}Sb_2Te_4$			0 0 0.42725(14)	0.1145 / 0.1145 / 0.771	1.10(9)
	$Ge_{0.25}Sn_{0.75}Sb_2Te_4$			0 0 0.4277(2)	0.0572 / 0.1718 / 0.771	1.90(14)
Te	$Ge_{0.75}Sn_{0.25}Sb_2Te_4$	A1	6 <i>c</i>	0 0 0.13205(15)	1	1.61(11)
	$Ge_06Sn_04Sb_2Te_4$			0 0 0.13208(15)	1	1.21(11)
	$Ge_0 {}_5Sn_0 {}_5Sb_2Te_4$			0 0 0.13251(14)	1	1.58(12)
	$Ge_{0.25}Sn_{0.75}Sb_2Te_4$			0 0 0.1324(2)	1	1.55(12)
Te	$Ge_{0.75}Sn_{0.25}Sb_2Te_4$	A2	6 <i>c</i>	0 0 0.2900(2)	1	1.61(11)
	$Ge_{0.6}Sn_{0.4}Sb_2Te_4$			0 0 0.2904(2)	1	1.21(11)
	$Ge_{0.5}Sn_{0.5}Sb_2Te_4$			0 0 0.28993(18)	1	1.58(12)
	$Ge_{0.25}Sn_{0.75}Sb_2Te_4$			0 0 0.2898(3)	1	1.55(12)

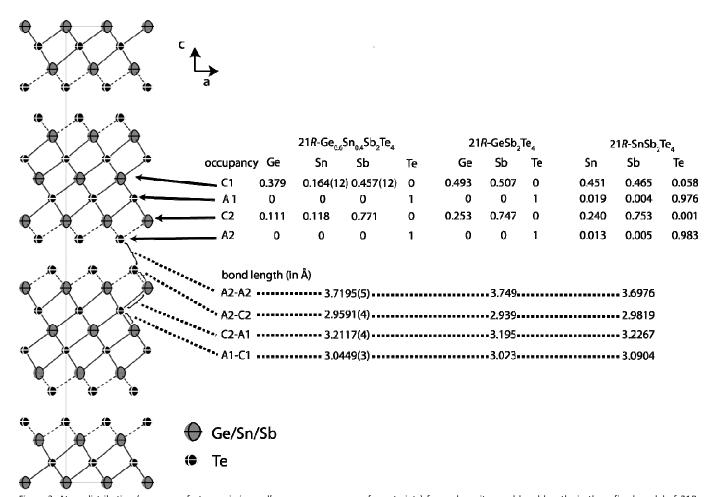


Figure 3: Atom distribution (occupancy factors, missing esd's are a consequence of constraints) for each position and bond lengths in the refined model of 21R-Ge_{0.6}Sn_{0.4}Sb₂Te₄ at 293 K (displacement ellipsoids drawn at 99 % probability level) compared with GeSb₂Te₄^[25] and SnSb₂Te₄^[23] (cation-anion antisite disorder is not significant in SnSb₂Te₄, the e.s.d.'s of the occupancy factors are \sim 0.006).

Table 3: Crystallographic data on the structure refinement of 21R-Ge_{0.6}Sn_{0.4}Sb₂Te₄ at 293 K; residual electron density averaged over all datasets.

			Ge _{0.6} Sn _{0.4}	Sb ₂ Te ₄		
Formula mass (in g mol ⁻¹)			1058	.96		
Cell parameters (in Å)			a = 4.26384(14)	c = 41.346(3)		
Cell volume (in Å ³)			650.97	, , ,		
Crystal system / space group			trigonal, $R\overline{3}n$	n (no. 166)		
X-ray density (in gcm ⁻³)			6.4	7		
F(000)			104	8		
Formular units (per unit cell)			3			
crystal size (in mm)			0.10 · 0.0	9 · 0.01		
Wavelength (in Å)	0.71073	0.56356	0.42468	0.40681	0.38979	all datasets
$\sin(\theta)/\lambda$	0.70	0.75	0.65	0.55	0	.60
Absorption coefficient (in mm ⁻¹)	22.47	11.91	5.55	9.34	12	2.04
Measured / independent reflections $\begin{array}{c} R_{\text{int}} \\ R_{\sigma} \end{array}$	2667 / 370 0.0634 0.0268	2112 / 366 0.0408 0.0374	5351 / 790 0.0310 0.0252	5334 / 383 0.0401 0.0380	0.0	6 / 370 0392 0277
Parameters / restraints			22 /	15		
Residual electron density (min / max) (in eÅ ⁻³)			-1.91 /	+3.36		
$R_{(obs)}^{\ \ (a)} \ WR_{(obs)}^{\ \ \ (b)} \ R_{(all)}^{\ \ (a)} \ WR_{(all)}^{\ \ \ (b)} \ GooF_{(obs)}$	0.0370 0.0544 0.0424 0.0563 1.25	0.0533 0.1082 0.0596 0.1092 2.25	0.0419 0.0898 0.0500 0.0918 1.93	0.0473 0.1021 0.0536 0.1053 2.24	0.0366 0.0754 0.0513 0.0811 1.53	0.0362 0.0509 0.0411 0.0516 1.59
$GooF_{(all)}$	1.15	2.04	1.73	2.08	1.41	1.46

^(a) $R=\sum |F_o-F_c|/\sum |F_o|$.

Table 4: Structure parameters of 21R-Ge_{0.6}Sn_{0.4}Sb₂Te₄ at 293 K: atom positions and coordinates, occupancy factors (on each position two parameters were refined and the other is calculated from the difference to full occupancy), equivalent isotropic (u_{eq} in \mathring{A}^2) and anisotropic displacement parameters (u_{ij} in \mathring{A}^2 ; $u_{23} = u_{13} = 0$

Atom	Position	Wyckoff	X	у	Z	Occupancy	u_{eq}	$u_{11} = u_{22} = 2 \cdot u_{12}$	u_{33}
Ge/Sn/Sb	C1	3 <i>a</i>	0	0	0	Ge 0.379			
						Sb 0.457(12)	0.02466(17)	0.0235(2)	0.0269(3)
						Sn 0.164(12)			
Ge/Sn/Sb	C2	6 <i>c</i>	0	0	0.426568(11)	Ge 0.111			
						Sb 0.771	0.02434(12)	0.02234(14)	0.0284(2)
						Sn 0.118			
Te	A1	6 <i>c</i>	0	0	0.132947(8)	Te 1	0.01858(11)	0.01922(13)	0.01729(17)
Te	A2	6 <i>c</i>	0	0	0.289989(7)	Te 1	0.01581(10)	0.01666(13)	0.01412(17)

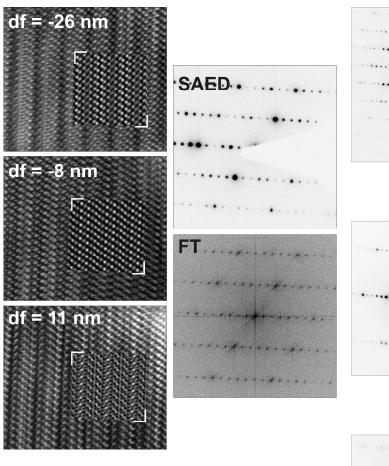
HRTEM images and diffraction patterns of a thinned crystal of Ge_{0.75}Sn_{0.25}Sb₂Te₄ whose composition was confirmed by TEM-EDX (measured $Ge_{12,2(7)}Sn_{5,5(11)}Sb_{29(2)}Te_{53(2)}$; calculated Ge_{10.7}Sn_{3.6}Sb_{28.6}Te_{57.1}) match well with simulations (Figure 4 and 5). The average c parameter from TEM experiments is 41(1) Å in accordance with the 41.346(3) Å obtained by X-ray diffraction (Table 1). No phase separation or exsolution was observed; the sample is homogeneous. In the SAEDs as well as in the Fourier transform of the HRTEM image every seventh reflection is strong, which indicates that there are seven layers

per rocksalt-type slab corresponding to a trigonal structure (R3m) with a 21R stacking sequence. The variance of the interatomic distances derived from X-ray data is also visible in the HRTEM images; they show sequences of 7 atom layers are separated by van der Waals gaps (Figure 4). This is confirmed by image simulations based on the structure model of Ge_{0.75}Sn_{0.25}Sb₂Te₄ determined by Rietveld refinement on X-ray powder data. No diffuse intensities along [001]* are visible in the SAED patterns; therefore, no stacking disorder is present.

⁽b) $wR = \left[\sum \left[w(F_0 - F_c)^2\right] / \sum \left[w(F_0)^2\right]\right]^{1/2}; w = 1/\left[\sigma^2(F_0) + 0.0004(F_0^2)\right].$

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Fgure 4 Fourier filtered HRTEM images (zone axis <100>, different defocus values) with inserted image simulations (thickness 6 unit cells along the viewing direction, C_s = 1.2, spread of defocus 2.14 nm, beam semiconvergence angle of 0.4 mrad) based on the structure model for $Ge_{0.75}Sn_{0.25}Sb_2Te_4$ determined by Rietveld refinement on X-ray powder data (left); corresponding Fourier transform (for df = -8 nm) and SAED pattern (right).

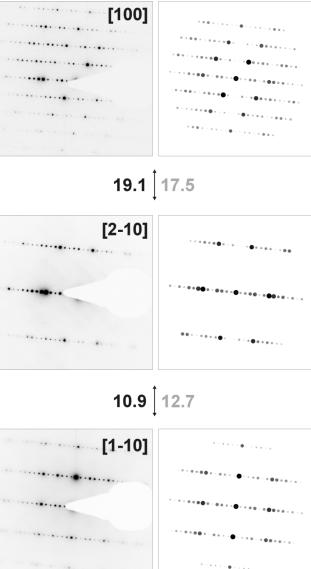


Figure 5: SAED patterns of Ge_{0.75}Sn_{0.25}Sb₂Te₄ and corresponding simulations (kinematical intensities) based on the corresponding structure model determined by Rietveld refinement (cf. Tables 1 and 2) with calculated (black) and measured (gray) tilt angles between the zone axes.

Mixed crystals $(Ge_{1-x}Sn_x)_2Sb_2Te_5$ (x = 0.35, 0.5)

Rietveld refinements comfirm that homogemeous samples of $(Ge_{1-x}Sn_xTe)_2Sb_2Te_3$ with x = 0.50 and 0.35 could be obtained by melting stoichiometric amounts of the pure elements, quenching in water and subsequently annealing them. The compounds are isostructural to the end member 9P-Ge₂Sb₂Te₅; however, the other end member Sn₂Sb₂Te₅ does not exist. A sample with x = 0.75 contains a small amount of a side phase. This is most likely due to a partial decomposition, [8] probably into $Ge_{1-x}Sn_xSb_2Te_4$ and $Ge_{1-x}Sn_xTe$. Structure refinements using the Rietveld method were carried out with powder diffraction data of GeSnSb₂Te₅ and Ge_{1.3}Sn_{0.7}Sb₂Te₅ (cf.

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Experimental Section). Constraints concerning the sum formula and element distribution set up in the same way as explained above for $(Ge_{1-x}Sn_x)Sb_2Te_4$. Figure 6 shows the result of the Rietveld refinement of $GeSnSb_2Te_5$, the corresponding data for $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ are presented in the Supplementary Information (Figure S5). Further information about the refinements of $GeSnSb_2Te_5$ and $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ powder samples is given in Table 5, the refined atom parameters are listed in Table 6.

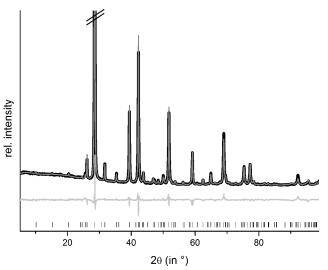


Figure 6: Rietveld refinement of 9*P*-GeSnSb₂Te₅; (the strongest reflection is cut off); vertical lines indicate calculated reflection positions, experimental (black) and calculated pattern (gray) and difference plot (below) are shown.

A single crystal obtained by chemical transport was used for resonant diffraction experiments in order to precisely determine the element distribution. The composition of the single crystal was determined by SEM-EDX. Taking into account electroneutrality, the formula is very close to $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ (experiment: $Ge_{15.7(10)}Sn_{8.2(2)}Sb_{21.6(4)}Te_{54.4(14)}$, calculated: $Ge_{14.4}Sn_{7.8}Sb_{22.2}Te_{55.6}$).

Similar to Ge₂Sb₂Te₅, Ge_{1.3}Sn_{0.7}Sb₂Te₅ forms the 9*P*-Pb₂Bi₂Se₅ structure type with 9 alternating anion and cation layers, respectively, per distorted rocksalt-type slab and unit cell. The slabs contain two additional layers compared to 21*R*-GeSb₂Te₄ but their arrangement is very similar (cf. Figure 7). Further information about the structure analysis is given in the Experimental Section, Table 7 presents details of the refinement; refined atom parameters are given in Table 8.

Figure 7 gives an overview of the structure and the element distribution in comparison with Ge₂Sb₂Te₅. The Te atoms at the van der Waals gap (A3) have a distance of 3.728 Å to the next slab, which is slightly larger than for Ge_{0.6}Sn_{0.4}Sb₂Te₄ (3.720 Å). The bond length alteration in the rocksalt-type slabs is comparable to 21R-type (Ge_{1-x}Sn_x)Sb₂Te₄ phases described above. The coordination sphere of cations near the van der Waals gap (C2) corresponds to distorted octahedrons with shorter bonds (2.939 Å) to the unsaturated Te atoms at the van der Waals gap (A3) and longer ones to the Te atom in the middle of the slab (A2, 3.232) Å; the bond angles indicate pronounced distortion (A3-C2-A3: 92.82°, A3-C2-A2: 92.17°, A2-C2-A2: 82.40°). The C1 octahedrons closer to the center of the slab are more regular with bond lengths of 2.996 and 3.082 Å to the Te atoms A1 and A2, respectively (bond angles: A1-C1-A1: 87.38°, A2-C1-A2: 90.57°; A2-C1-A1: 91.00°). In Ge_{1.3}Sn_{0.7}Sb₂Te, all bonds are slightly longer than in Ge_{0.6}Sn_{0.4}Sb₂Te₄ and Ge₂Sb₂Te₅. [24] This is due to the higher Sn content (ionic radii: Sn 0.69 Å, Ge 0.53 Å).[30] The larger Sb with its higher oxidation state concentrates on the position C2 near the van der Waals gap (occupancy 59.8%), where Sn (22.4%) is also slightly preferred in comparision to Ge (17.8%). The cation position C1 is occupied by more Ge (47.2%) than Sb (40.2%) and little Sn (12.6%). The atomic coordinates of Ge_{1.3}Sn_{0.7}Sb₂Te₅ obtained from single crystal refinement and Rietveld analysis, respectively, differ by up to 10σ . This is probably due to the fact that standard deviations are often underestimated in Rietveld method.

Table 5: Results from the Rietveld refinements for GeSnSb₂Te₅ and Ge_{1.3}Sn_{0.7}Sb₂Te₅.

Sum formula	$Ge_{1.3}Sn_{0.7}Sb_2Te_5$	$GeSnSb_2Te_5$
Formula mass (in g mol-1)	1059.01	1072.84
F(000)	386.6	392
Created existency and as aroun	trigonal / P 3	<i>Bm</i> 1 (no. 164)
Crystal system / space group Z		1
Cell parameters (in Å)	a = 4.25792(11)	a = 4.27486(7)
Cell volume (in Å ³)	c = 17.3657(14) $272.66(3)$	c = 17.4165(8) $275.635(16)$
X-ray density (in gcm ⁻³)	6.45	6.46
Absorption coefficient (in mm ⁻¹)	158.50	161.19
Wavelength (in Å)	Cu - $K_{\alpha l}$ (λ =	1.540596 Å)
2θ (in °)	$5 \le 2$	$\theta \le 99$
Profile function	fundamental parameters (d	irect convolution approach)
Restraints		6
Reflections	148	148
Parameters / thereof background	38 / 18	38 / 18
R_p / R_{wp}	0.0258 / 0.0375	0.0226 / 0.0340
$R_{ m Bragg}$	0.0212	0.0158
Goof	1.660	1.430

Table 6: Wyckoff-positions, atom coordinates, occupancy factors (cf. text: according to nominal composition, not refined), isotropic displacement parameters (in Å³) for GeSnSb₂Te₅ and Ge_{1,3}Sn_{0,7}Sb₂Te₅ from powder data.

Atom	Formula	Position	Wyckoff position	x y z	Occupancy	$\mathrm{B}_{\mathrm{iso}}$
Те	$\begin{array}{c} Ge_{1.3}Sn_{0.7}Sb_2Te_5 \\ GeSnSb_2Te_5 \end{array}$	A1	1a	0 0 0 0 0 0	1 1	1.56(10) 1.41(8)
Ge/Sn/Sb	$\begin{array}{c} Ge_{1.3}Sn_{0.7}Sb_2Te_5 \\ GeSnSb_2Te_5 \end{array}$	C1	2d	2/3 1/3 0.1190(11) 2/3 1/3 0.1097(9)	0.472 / 0.126 / 0.402 0.299 / 0.299 / 0.402	1.70(13) 2.26(10)
Te	$\begin{array}{c} Ge_{1.3}Sn_{0.7}Sb_2Te_5 \\ GeSnSb_2Te_5 \end{array}$	A2	1a	1/3 2/3 0.2065(8) 1/3 2/3 0.2082(6)	1 1	1.56(10) 1.41(8)
Ge/Sn/Sb	$\begin{array}{c} Ge_{1.3}Sn_{0.7}Sb_2Te_5 \\ GeSnSb_2Te_5 \end{array}$	C2	2c	0 0 0.3235(6) 0 0 0.3244(5)	0.178 / 0.224 / 0.598 0.201 / 0.201 / 0.598	1.70(13) 2.26(10)
Te	$\begin{array}{c} Ge_{1.3}Sn_{0.7}Sb_2Te_5 \\ GeSnSb_2Te_5 \end{array}$	A3	2d	2/3 1/3 0.4183(8) 2/3 1/3 0.4189(6)	1 1	1.56(10) 1.41(8)

· • • • • • • • • • • • • • • • • • • •								
			9 <i>P-</i> Ge _{1.3} Sn	_{α,} Sb₂Te₅		9 <i>P</i> -C	Se ₂ Sb ₂ Te ₅	
	occupancy	Ge	Sn	Sb	Te	Ge	Sb	Te
(e)	— A1	0	0	0	1	O	0	1
* * * * * * * * * *	—— C1	0.472	0.126	0.402	0	0.60	0.36	0
	— A2	0	0	0	1	o	0	1
	 c2	0.178(3)	0.224	0.598(6)	0	0.37	0.66	0
6 6 6	— Аз	0	0	0	1	c	o	1
	bond ler **** A3-A3	ngth (in Å)	••••• 3.72	281(5)			3.7266	
	**** A3-C2	•••••	2.93	394(4)			2,9132	
	**** C2-A2	•••••	3.23	322(4)			3.2038	
	**** A2-C1	•••••	2.99	959(4)			2.9645	
	^{(**} **• C1-A1	••••••	3.08	321(3)			1840.5	
	Θ	Ge/Sn/	Sb					
	(Te						

Figure 7: Atom distribution (occupancy factors, missing esd's are a consequence of constraints) for each element and bond lengths in the refined model of $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ at 293 K (displacement ellipsoids drawn at 99 % probability level) compared with $Ge_2Sb_2Te_5$ [24]

TEM investigations of quenched bulk samples of GeSnSb₂Te₅ corroborate the structure and composition of this quarternary phase, TEM-EDX measurements $Ge_{12,1(2)}Sn_{12,3(2)}Sb_{23,2(5)}Te_{52,5(5)}$ (calculated for $GeSnSb_2Te_5$: Ge_{11.1}Sn_{11.1}Sb_{22.2}Te_{55.5}). For a crushed fragment of the ingot with the nominal composition $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ used for thermoelectric characterization (see below), EDX yields $Ge_{14.8(2)}Sn_{9.5(2)}Sb_{21.6(5)}Te_{54.0(5)}$ (calculated for $Ge_{1.3}Sn_{0.7}Sb_2Te_5$: Ge_{14.4}Sn_{7.8}Sb_{22.2}Te_{55.5}). HRTEM images as well as SAED patterns of the same sample show a d-value of 17 Å which corresponds to the [001]* direction of 9P-Ge2-xSnxSb2Te5. Diffuse streaks along [001]* (cf. Figure 8) indicate a certain degree of stacking disorder or the presence of rocksalt-type slabs with varying thickness.

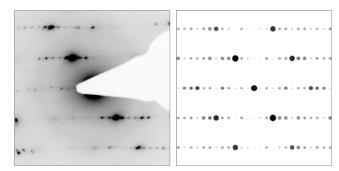


Figure 8: Experimental SAED pattern (zone axis <110>, left) of a crystal from a bulk sample of $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ and a corresponding calculated one (right) based on the structure model from $Ge_{1.3}Sn_{0.7}Sb_2Te_5$.

Table 7: Crystallographic data on the structure refinement of 9P- Ge_{1.3}Sn_{0.7}Sb₂Te₅ at 293 K; residual electron density averaged over all datasets.

a = 4.25793(11), $c = 17.3657(14)$						
270.83(7)						
$0.20\cdot0.09\cdot0.03$						
0.38979	all datas					
0.50	datas					
12	2.12					
8440 / 950 0.0391 0.0254						
0.0350	0.039					
	0.072					
	0.047					
	0.07					
	1.53 1.41					
	0.0350 0.0700 0.0456 0.0745 1.46 1.37					

⁽a) $R=\sum |F_0-F_c|/\sum |F_0|$.

Table 8: Structure parameters of 9P- Ge_{1.3}Sn_{0.7}Sb₂Te₅ at 293 K: atom positions and coordinates, occupancy factors (on each position two parameters were refined and the other is calculated from the difference to full occupancy), equivalent isotropic (u_{eq} in \mathring{A}^2) and anisotropic displacement parameters (u_{ij} in \mathring{A}^2 ; $u_{23} = u_{13} = 0$

Atom	Position	Wyckoff	X	у	Z	Occupancy	u_{eq}	$u_{11} = u_{22} = 2 \cdot u_{12}$	u_{33}
Te1	A1	1a	0	0	0	Te 1	0.01699(10)	0.01752(13)	0.01593(17)
Ge/Sn/Sb2	C1	2d	2/3	1/3	0.10705(3)	Sb 0.402(6) Ge 0.472(3)	0.02547(13)	0.02393(16)	0.0286(2)
						Sn 0.126(7)			
Te3	A2	2d	1/3	2/3	0.205655(18)	Te 1	0.01729(9)	0.01789(11)	0.01608(15)
Ge/Sn/Sb4	C2	2c	0	0	0.32650(3)	Sb 0.598(6) Ge 0.178(3) Sn 0.224(7)	0.02326(10)	0.02144(13)	0.02692(18)
Te5	A3	2d	2/3	1/3	0.41930(2)	Te 1	0.02015(9)	0.02072(12)	0.01900(16)

Thermoelectric properties

Ge_{0.6}Sn_{0.4}Sb₂Te₄ and Ge_{1.3}Sn_{0.7}Sb₂Te₅, for which single-crystal data are available, as well as GeSnSb₂Te₅ show metallic behavior of the electrical conductivity σ , the absolute values are similar and lie in the range of poor metals (cf. Figure 9). Compared to water-quenched GeSb₂Te₄ and Ge₂Sb₂Te₅, which exhibit the crystal structure of the corresponding stable phases, the values of the Sn-containing samples are lower by a factor of $3^{[33]}$ σ of $Ge_0 {}_6Sn_0 {}_4Sb_2Te_4$ is about 50% of that of melt-spun, i. e. rapidly solidified GeSb₂Te₄ at room temperature and 75% at 430 °C, respectively, while the values of melt-spun Ge₂Sb₂Te₅ [33] are approximately equal to those of quenched Ge_{1.3}Sn_{0.7}Sb₂Te₅ as reported here. The Seebeck coefficients S

of the samples investigated are very similar. The values for Ge_{1.3}Sn_{0.7}Sb₂Te₅ and GeSnSb₂Te₅ are in the same range as those of water-quenched Ge₂Sb₂Te₅ and ~25% lower than those of the melt spun compound between 180 °C and 380 °C.[33] This might be due to grain boundaries or anti-site defects in the melt spun sample.

The difference in the ZT values is a consequence of the different thermal conductivities k. These are only 67% (Ge_{1.3}Sn_{0.7}Sb₂Te₅) and 56% (Ge_{0.6}Sn_{0.4}Sb₂Te₄), respectively, of those of unsubstituted samples (3.2 W/mK for GeSb₂Te₄ and 3.0 W/mK for Ge₂Sb₂Te₅ at room temperature). [34] The phononic part κ_L of the thermal conductivity (electronic part calculated using $L = 2.44 \cdot 10^{-8} \text{ V}^2\text{K}^{-2}$ which is a typical value for good metals and degenerate semiconductors.^[35]) decreases

⁽b) $wR = \left[\sum \left[w(F_0 - F_c)^2\right] / \sum \left[w(F_0)^2\right]\right]^{1/2}$; $w = 1/\left[\sigma^2(F_0) + 0.0016(F_0^2)\right]$

slightly with increasing temperature for Ge_{0.6}Sn_{0.4}Sb₂Te₄ and Ge_{1.3}Sn_{0.7}Sb₂Te₅ while it increases for GeSnSb₂Te₅. Therefore, Sn substitution reduces κ for lower substitution rates $(Ge_{1.3}Sn_{0.7}Sb_2Te_5)$ and $Ge_{0.6}Sn_{0.4}Sb_2Te_4$ compared Ge₂Sb₂Te₅ and GeSb₂Te₄), which results in higher ZT values up to 0.25 than those of the unsubstituted samples (ZT up to 0.2). [33] Since κ of GeSnSb₂Te₅ increases with the temperature, its ZT value at high temperatures is significantly lower than that of Ge_{1.3}Sn_{0.7}Sb₂Te₅

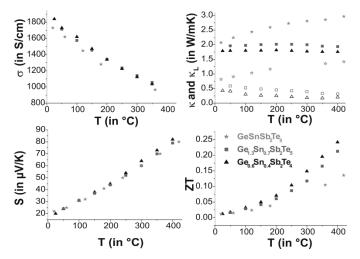


Figure 9: Thermoelectric properties of $Ge_{0.6}Sn_{0.4}Sb_2Te_4$, $Ge_{1.3}Sn_{0.7}Sb_2Te_5$ and GeSnSb₂Te₅: electrical conductivity and Seebeck coefficient (left side top to bottom); lattice thermal conductivity (κ bold and κ_l open faced) and thermoelectric figure of merit (right side top to bottom)

Conclusion

Homogeneous bulk samples of Sn-substituted GST materials have so far been investigated predominantly as thin films, because their performance as PCMs can be enhanced by substituting Sn into the structure. [5,6,10] Compounds with a similar composition but a different structure could be obtained as bulk samples by quenching stoichiometric melts of elements involved. The layered phases $Ge_{0.6}Sn_{0.4}Sb_2Te_4$ Ge_{1.3}Sn_{0.7}Sb₂Te₅ show improved thermoelectric properties compared to the stable modifications of GeSb₂Te₄ and Ge₂Sb₂Te₅ since the thermal conductivity is decreased while the Seebeck coefficient remains nearly unaffected at high temperatures (~400 °C). The lower thermal conductivity might be due to the introduction of an additional element in the cation substructure that can act as a phonon scattering center. Detailed structural data on the element distribution obtained from single crystals grown by chemical transport reactions show that the cations are not randomly distributed but exhibit clear preferences for certain positions. Ge1-xSnxSb2Te4 and (Ge_{1-x}Sn_x)₂Sb₂Te₅ form layered phases comparable to those known from the corresponding stable modifications of GST materials. The trend of the element distribution is comparable in the new Sn-containing compounds as well as in unsubstituted GeSb₂Te₄, Ge₂Sb₂Te₅ and other compounds with the same structure type like SnSb₂Te₄, PbSb₂Te₄ and GeBi₂Te₄. [23-25,31,32]

The position near the van der Waals gap is preferably occupied by Sb, whereas the position in the center of the distorted rocksalt-type slabs is shared by almost equal amounts of Sb and Ge. Sn shows a slight preference for the position near the van der Waals gap. This element distribution can be explained by the unsaturated coordination of the Te atoms next to the van der Waals gaps, which can be compensated more effectively by Sb³⁺ than by Ge²⁺ due to the higher formal charge. The polarizability and covalent bonding character may also play a role and explain why the behavior of Sn is comparable to that of Sb, yet to a lesser extent. The Te-Te distances at the van der Waals gaps are nearly the same for all of the stable 21*R*-type and 9P-type compounds whereas the cation-anion bond lengths increase slightly with increasing Sn content.

Layered GST materials substituted with Sn open a field of easily accessible thermoelectrics which can be produced as bulk material in large amounts. The use of Sn instead of much more expensive Ge may also reduce the cost significantly. As these phases are thermodynamically stable, thermoelectric properties are not influenced by changing nanostructures or by decomposition. The results concerning the element distribution and the distortion of coordination polyhedra may also be valuable as a model for PCMs in order to describe the local environment in amorphous and crystalline thin films of Sn-doped GST materials.

Experimental Section

Sample preparation

Bulk samples were prepared by melting stoichiometric mixtures of the elements Ge (99.999%, Aldrich), Sn (99.99%, Alfa Aesar), Sb (99.9999%, Smart Elements) and Te (99.999%, Alfa Aesar) in sealed silica glass ampoules under argon atmosphere at 950 °C (for 2 h - 24 h) and quenching in water. Subsequently, the samples were annealed about 48 h at temperatures between 450 °C and 590 °C (detailed information can be found in Table S1 in the Supplementary Information). Samples for thermoelectric measurements (ca. 3-4 g) were melted at 950 °C (2 h) in ampoules with a flat bottom, quenched in air, annealed (Ge_{0.6}Sn_{0.4}Sb₂Te₄: 6 d at 540 °C; $Ge_{1.3}Sn_{0.7}Sb_{2}Te_{5}$: 2 d at 490 °C; $GeSnSb_{2}Te_{5}$: 20 h at 550 °C) and subsequently quenched in air. Single crystals of $Ge_0 {}_6Sn_0 {}_4Sb_2Te_4$ and $Ge_0 {}_{75}Sn_0 {}_{25}Sb_2Te_4$ were grown by chemical transport reactions in sealed silica glass ampoules under vacuum using ~20 mg of I₂ with temperature gradients from ca. 580 °C to 500 °C for 1 d (composition of the starting material: Ge_{0.5}Sn_{0.5}Sb₂Te₄ and GeSnSb₂Te₅, respectively). Ge_{1.3}Sn_{0.7}Sb₂Te₅ crystals were grown at ~600 °C (20 h) using the intrinsic gradient of a tube furnace for 20 h from GeSnSb₂Te₅ as starting material, adding 20 mg of SbI₃ as a transport agent. In all cases, plate-like single crystals could be obtained from the cold end of the ampoule; residual transport agent was removed by washing with acetone.

Electron microscopy and X-ray spectroscopy

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The composition of the single crystals used for structure determination was confirmed by energy dispersive X-ray spectroscopy (EDX) on planar crystal faces using a Jeol JSM-6500F scanning electron microscope with EDX detector (model 7418, Oxford Instruments).

For TEM investigations on Ge_{1.3}Sn_{0.7}Sb₂Te₅, a finely powdered part of the sample used for thermoelectric measurements was dispersed on a copper grid coated with holey carbon film. Single crystals of Ge_{0.75}Sn_{0.25}Sb₂Te₄ (EDX analysis see above) grown by chemical transport were embedded in two-component glue and placed between silicon wafers and glass panels. These "sandwiches" were fixed in brass tubes with an inner diameter 2 mm. Slices of 0.2 mm thickness were cut from the tube and polished to 80-90 µm thickness using SiC coated sand papers. In the middle of the disks, conical cavities were produced using a dimple grinder (model 650, Gatan) and diamond polishing paste (Electron Microscopy Science) and holes were fabricated using a precision argon ion polishing system (model 691, Gatan). The samples were mounted on a double-tilt holder with maximum tilt angles of ±30°. The measurements were performed on a FEI Titan 80-300 equipped with a fieldemission gun operating at 300 kV, a Gatan UltraScan 1000 (2k x 2k) camera and an EDX detector system TOPS 30 (EDAX). The results were evaluated using the Digital Micrograph^[36] and ES Vision^[37] software packages. SAED patterns were calculated applying the kinematical approximation and HRTEM images were simulated using the multislice method as implemented in the JEMS^[38] and EMS program package.^[39]

X-ray powder diffraction

X-ray powder patterns were recorded on a Huber G670 Guinier camera equipped with a fixed imaging plate and integrated system using $Cu-K_{\alpha 1}$ radiation monochromator, $\lambda = 1.54056 \text{ Å}$). Specimens were prepared by crushing representative parts of the samples and fixing powders on Mylar foils using hair-fixing spray. Lattice parameters were determined by pattern fitting (Rietveld method) using TOPAS ACADEMIC [40] with structure models obtained from the single-crystal structure analyses. Shifted Chebychev background functions were used, crystallite strain was described using a Voigt function and preferred orientation was refined with spherical harmonics of the 6th order. All functions are implemented in the TOPAS program suite. Atomic coordinates were set equal for atoms sharing one position and one common isotropic displacement parameter each was used for anions and cations, respectively. Further details of the Rietveld refinements are available from Fachinformationszentrum Karlsruhe, D-76344 Eggenstein-Leopoldshafen (Germany), on quoting the depository numbers CSD-426668 $(Ge_{0.75}Sn_{0.25}Sb_2Te_4),$ CSD-426672 $(Ge_{0.5}Sn_{0.5}Sb_2Te_4)$, CSD-426667 $(Ge_{0.25}Sn_{0.75}Sb_2Te_4)$ and CSD-426669 (GeSnSb₂Te₅) as well as the names of the authors and citation of the paper (Fax: +49-7247-808-666; E-mail: crysdata@fiz-karlsruhe.de).

Single crystal and synchrotron diffraction methods

Laboratory single crystal datasets were recorded on an IPDS I diffractometer (Stoe & Cie.) with an imaging plate detector using Mo- K_{α} radiation (graphite monochromator, λ = 0.71073 Å). Synchrotron data of the same crystals were collected at beamline ID11^[41] of the ESRF (Grenoble) on a heavy-duty diffractometer (Huber) with vertical rotation axis equipped with a Frelon2K CCD detector. The beamline provides a beam tuneable by undulators in the required energy range from 22 keV to 32 keV (0.56 Å to 0.39 Å) near the K absorption edges of Sn (29.195 keV, 0.42468 Å), Sb (30.477 keV, 0.40681 Å), Te (31.818 keV, 0.38979 Å) and far away from the edges (22.00 keV, 0.56357 Å). In order to measure high-angle data, a detector offset was used. The datasets were indexed and integrated using SMART^[42] and SAINT.^[43] Laboratory datasets were absorption corrected numerically using XRED^[44] and XSHAPE; [45] synchrotron data consisted of several different datasets, which were combined and absorption corrected semiempirically using SADABS. [46] In both cases, the Laue symmetry $\overline{3}m$ was applied. Joint least-squares refinements employing multiple datasets [19] were carried out with JANA2006. [47] The dispersion correction terms $\Delta f'$ and $\Delta f''$ were calculated from X-ray fluorescence spectra (energydispersive XFlash detector; Rontec) via the Kramers-Kronig transform^[48] using the program CHOOCH.^[49] The refinement aimed at determining the element distribution in the compounds simultaneously for each element on each crystallographic position; full total occupancy was assumed on all atom positions as suggested by the results of previous investigations. [22-24] Occupancy factors were constrained in order to fix the sum formula according to the result of the EDX measurements to prevent the overall scale factor from diverging. Elements with occupancy factors close to zero within their standard deviation (or slightly negative) were deleted on the respective positions until only elements with occupancy factors $> 3 \sigma$ were present. Atomic coordinates and ADPs of atoms occupying the same site were set equal. Cell parameters determined from powder samples have been used due to their higher precision. Further details of the singlecrystal structure investigation are available from the Fachinformationszentrum Karlsruhe, D-76344 Eggenstein-Leopoldshafen (Germany), on quoting the depository number, CSD-426670 $(Ge_{0.6}Sn_{0.4}Sb_{2}Te_{4})$ and CSD-42671 (Ge_{1.3}Sn_{0.7}Sb₂Te₅) as well as the names of the authors and citation of the paper (Fax: +49-7247-808-666; E-mail: crysdata@fiz-karlsruhe.de).

Thermoelectric properties

Commercial and in-house-built facilities of the DLR (Cologne) were used to determine the temperature dependence of the electrical and thermal conductivities as well as the Seebeck coefficient from room temperature up to approximately 500 °C under He atmosphere. Peltier influences on the measurement of the electrical conductivity were reduced by a four-point-probe setup using an AC method (low frequency method using 7 Hz). The electrical resistivity was calculated according to $\rho = (1/G_F) \cdot R$ (G_F: correction of cross section and thickness of

the sample as well as distance between probe tips). For the determination of the Seebeck coefficient a small temperature gradient across the sample was established while slowly changing the environment temperature in order to obtain Seebeck coefficients for each mean sample temperature. Type-N thermocouples were directly attached to the sample in order to measure both the Seebeck voltage and the temperature. [50,51] The thermal conductivity was calculated from the thermal diffusivity (measured using a laser-flash apparatus, Netzsch LFA 427), the heat capacity (determined by differential scanning calorimetry, Netzsch DSC 404), and the density of the samples (measured using a Mohr's balance). The experimental errors were estimated at 5% for the electrical conductivity, 5% for the Seebeck coefficient, and 8% for the thermal conductivity. The data were calculated by averaging between heating and cooling measurements; the values were interpolated to get 50 °C steps in order to calculate ZT and κ_L .

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Notes and references

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Electronic Supplementary Information (ESI) available: [additional graphics, a table and Rietveld plots for $Ge_{0.75}Sn_{0.25}Sb_2Te_4$, $Ge_{0.6}Sn_{0.4}Sb_2Te_4$, $Ge_{0.25}Sn_{0.75}Sb_2Te_4$, $Ge_{1.3}Sn_{0.7}Sb_2Te_5$]. See DOI: 10.1039/b000000x/

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